



DOCKET NUMBER: 2312-0866-2PCT/pmh

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

RE APPLICATION OF:  
Kimihiro MATSUSE, et al.

: GROUP: 2814

SERIAL NUMBER: 09/530,588

: ATTENTION:  
Application Division  
Customer Corrections

FILED: MAY 05, 2000

FOR: METHOD OF FORMING SEMICONDUCTOR WIRING STRUCTURES

*Receipt  
#DZPA  
CFR  
3/6/03  
AJones*

REQUEST FOR CORRECTED OFFICIAL FILING RECEIPT

Assistant Commissioner for Patents  
Washington, D.C. 20231

Sir:

The Patent Office is requested to provide a corrected Official Filing Receipt for the attached. No fees are required. If you have any questions, please do not hesitate to contact us.

Respectfully submitted,

OBLON, SPIVAK, McCLELLAND,  
MAIER & NEUSTADT, P.C.

*Joseph A. Scafetta Jr.*

Marvin J. Spivak  
Attorney of Record  
Registration Number 24,913  
Joseph A. Scafetta, Jr.  
Registration No. 26,803

RECEIVED  
FEB 28 2003  
TECHNOLOGY CENTER 2800

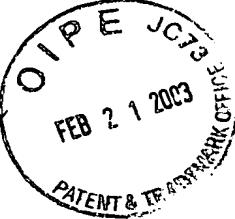


**22850**

Tel. (703) 413-3000  
Fax. (703) 413-2220  
(OSMMN 10/98)

APPLICATION NUMBER	FILING DATE	GRP ART UNIT	FIL FEE REC'D	ATTY.DOCKET.NO	DRAWINGS	TOT CLAIMS	IND CLAIMS
09/530,588	05/05/2000	2814	2370	2312-0866-2P.T	4	8	4

OBLON SPIVAK MCCLELLAND  
MAIER & NEUSTADT  
1755 JEFFERSON DAVIS HIGHWA  
FOURTH FLOOR  
ARLINGTON, VA 22202



CONFIRMATION NO. 6686

CORRECTED FILING RECEIPT



\*OC00000009101113\*

Date Mailed: 11/14/2002

Receipt is acknowledged of a CPA in this regular Patent Application. It will be considered in its order and you will be notified as to the results of the examination. Be sure to provide the U.S. APPLICATION NUMBER, FILING DATE, NAME OF APPLICANT, and TITLE OF INVENTION when inquiring about this application. Fees transmitted by check or draft are subject to collection. Please verify the accuracy of the data presented on this receipt. If an error is noted on this Filing Receipt, please write to the Office of Initial Patent Examination's Filing Receipt Corrections, facsimile number 703-746-9195. Please provide a copy of this Filing Receipt with the changes noted thereon. If you received a "Notice to File Missing Parts" for this application, please submit any corrections to this Filing Receipt with your reply to the Notice. When the USPTO processes the reply to the Notice, the USPTO will generate another Filing Receipt incorporating the requested corrections (if appropriate).

#### Applicant(s)

KIMIHIRO MATSUSE, INAGI-SHI, JAPAN;  
HAYASHI OTSUKI, NAKAKOMA, JAPAN;

11/05/2002  
OBLON, SPIVAK, MCCLELLAND  
MAIER & NEUSTADT AC  
1755 JEFFERSON HIGHWAY DEPT.  
Initials are bracketed. 11/18/2002  
MAY 2003  
RECEIVED  
FEB 28 2003  
TECHNOLOGY CENTER 2800

#### Domestic Priority data as claimed by applicant

This application is a 371 of PCT/JP98/04983 11/05/1998

#### Foreign Applications

JAPAN 9-319059 11/05/1997  
JAPAN 10-207198 07/07/1998

If Required, Foreign Filing License Granted 06/06/2000

CPA filed on: 11/04/2002

Projected Publication Date: --> 02/20/2003

Non-Publication Request: No

Early Publication Request: No

#### Title

WIRING STRUCTURE OF SEMICONDUCTOR DEVICE, ELECTRODE, AND METHOD FOR FORMING THEM

#### Preliminary Class

257

PLEASE NOTE THAT THE SECOND APPLICANT'S CITY IS INCORRECT. IT SHOULD READ AS FOLLOWS:

2ND= HAYASHI OTSUKI, NAKAKOMA-GUN, JAPAN

PLEASE NOTE THAT THE TITLE IS INCORRECT. IT SHOULD READ AS FOLLOWS:

METHOD OF FORMING SEMICONDUCTOR WIRING STRUCTURES